

Trench Schottky Rectifier, Low Forward Voltage NTSA4100, NRVTSA4100

Features

- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- High Surge Capability
- NRVTSA Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Switching Power Supplies including Wireless, Smartphone and Notebook Adapters
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation
- LED Lighting

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting SurfaceTemperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

SCHOTTKY BARRIER RECTIFIERS 4 AMPERES 100 VOLTS



SMA CASE 403D STYLE 1

MARKING DIAGRAM



TH41 = Specific Device Code A = Assembly Location

Y = Year WW = Work Week ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

NTSA4100, NRVTSA4100

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	100	V
Average Rectified Forward Current (T _L = 118°C)	I _{F(AV)}	4.0	А
Peak Repetitive Forward Current, (Square Wave, 20 kHz, T _L = 110°C)	I _{FRM}	8.0	А
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	50	А
Storage Temperature Range	T _{stg}	-65 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
ESD Rating (Human Body Model)		1B	
ESD Rating (Charged Device Model)		> 1000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance, Junction-to-Lead, Steady State (Assumes 600 mm ² 1 oz. copper bond pad, on a FR4 board)	$R_{ heta JL}$	-	16.2	°C/W
Thermal Resistance, Junction-to-Ambient, Steady State (Assumes 600 mm² 1 oz. copper bond pad, on a FR4 board)	$R_{ heta JA}$	-	90	°C/W

ELECTRICAL CHARACTERISTICS

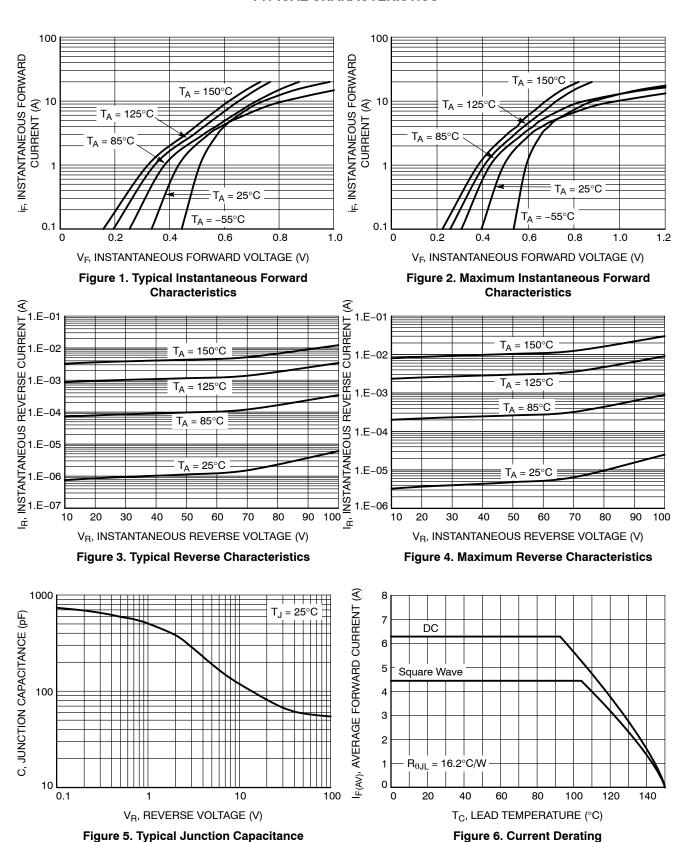
Instantaneous Forward Voltage (Note 1)	٧ _F			V
$(i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C})$		0.43	_	
$(i_F = 4.0 \text{ A}, T_J = 25^{\circ}\text{C})$		0.59	0.66	
(i 10 A T 105°C)		0.35		
$(i_F = 1.0 \text{ A}, T_J = 125^{\circ}\text{C})$			-	
$(i_F = 4.0 \text{ A}, T_J = 125^{\circ}\text{C})$		0.53	0.58	
Reverse Current (Note 1)	i _R			
(Rated dc Voltage, T _J = 25°C)		1.3	25	μΑ
(Rated dc Voltage, T _J = 125°C)		0.13	9	mA
Diode Capacitance	C _d			pF
(Rated dc Voltage, T _J = 25°C, f = 1 MHz)		54.7		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{1.} Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

NTSA4100, NRVTSA4100

TYPICAL CHARACTERISTICS



NTSA4100, NRVTSA4100

TYPICAL CHARACTERISTICS

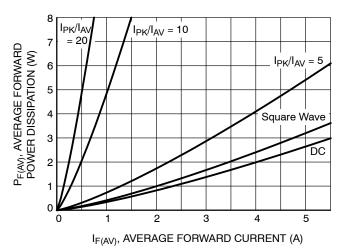


Figure 7. Forward Power Dissipation

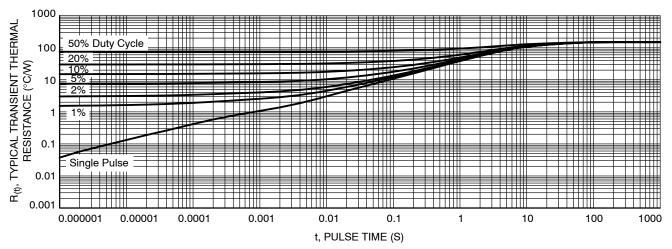


Figure 8. Typical Transient Thermal Response, Junction-to-Ambient

ORDERING INFORMATION

Device	Package	Shipping [†]
NTSA4100T3G	SMA (Pb-Free)	5000 / Tape & Reel
NRVTSA4100T3G	SMA (Pb-Free)	5000 / Tape & Reel
NRVTSA4100T3G-GA01	SMA (Pb-Free)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.







STYLE 1 STYLE 2

SCALE 1:1

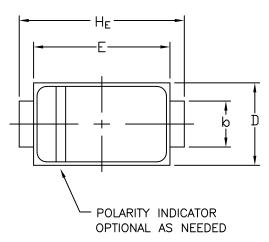


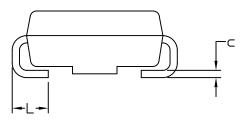
DATE 22 OCT 2021

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCHES
- DIMENSION 6 SHALL BE MEASURED WITHIN DIMENSION L.

	MILLIMETERS				INCHES		
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.	
Α	1.97	2.10	2.20	0.078	0.083	0.087	
A1	0.05	0.10	0.20	0.002	0.004	0.008	
b	1.27	1.45	1.63	0.050	0.057	0.064	
С	0.15	0.28	0.41	0.006	0.011	0.016	
D	2.29	2.60	2.92	0.090	0.103	0.115	
Ε	4.06	4.32	4.57	0.160	0.170	0.180	
HE	4.83	5.21	5.59	0.190	0.205	0.220	
L	0.76	1.14	1.52	0.030	0.045	0.060	

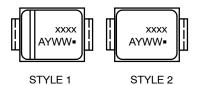




STYLE 1: PIN 1. CATHODE (POLARITY BAND) STYLE 2: 2. ANODE

NO POLARITY

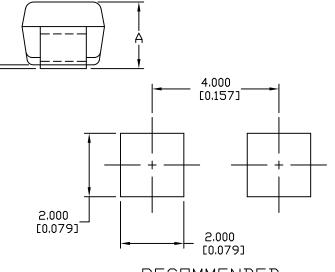
GENERIC MARKING DIAGRAM*



= Specific Device Code XXXX Α = Assembly Location

= Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to



RECOMMENDED MOUNTING FOOTPRINT

device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot "■", may
or may not be present. Some products may
not follow the Generic Marking.
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